

3-284932-3 ✓ ACTIVE



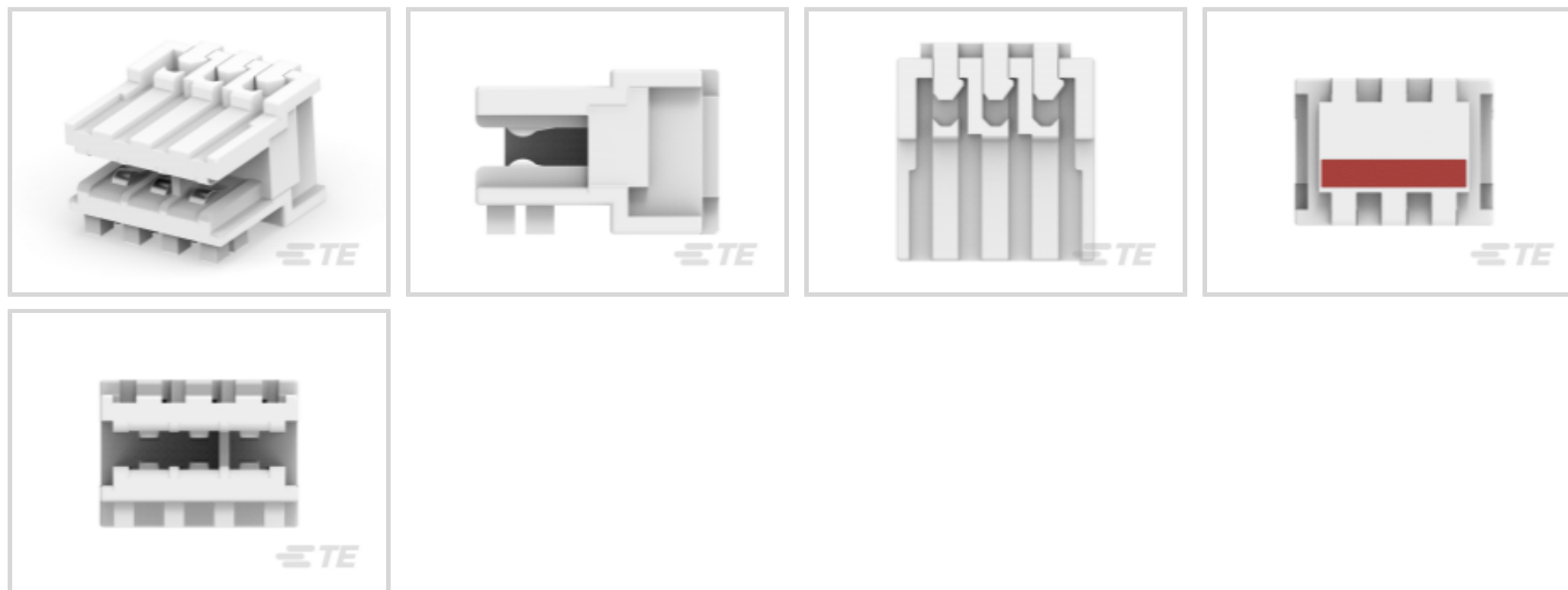
RAST

TE Internal #: 3-284932-3

Standard Edge Connectors, Wire-to-Board, 3 Position, .098 in [2.5 mm] Centerline, Insulation Displacement (IDC), 1 Row, Red, PBT GF, Fully Loaded

[View on TE.com >](#)

Connectors > PCB Connectors > Card Edge Connectors > Standard Edge Connectors



Connector System: **Wire-to-Board**

Number of Positions: **3**

Centerline (Pitch): **2.5 mm [.098 in]**

Termination Method to Wire & Cable: **Insulation Displacement (IDC)**

Number of Rows: **1**

Features

Product Type Features

Connector System	Wire-to-Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Card Entry Style	Side
Number of Insulation Displacement Slots	3
Compatible With Wire & Cable Type	Discrete Wire
Number of Positions	3
Number of Rows	1
Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Right Angle

Electrical Characteristics

Operating Voltage	63 VAC
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Body Features



Keying Between Cavity Locations	2&3
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Primary Product Color	Red
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Contact Features

Contact Retention Within Housing	Without
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PCB Contact Termination Area Plating Material Thickness	4 – 10 μ m
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Contact Type	Socket
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Contact Mating Area Plating Material	Tin
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PCB Contact Termination Area Plating Material	Tin
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Contact Base Material	Phosphor Bronze
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Contact Current Rating (Max)	2 A
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Termination Features

Termination Method to Wire & Cable	Insulation Displacement (IDC)
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Mechanical Attachment

Mating Alignment Type	Keyed
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Mating Retention	Without
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Mating Alignment	With
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PCB Mount Alignment	Without
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PCB Mount Retention	Without
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Connector Mounting Type	Board Mount
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Housing Features

Housing Entry Configuration	Both Ends Open
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Centerline (Pitch)	2.5 mm [.098 in]
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Housing Material	PBT GF
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Dimensions

Card Slot Depth	5 mm
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Connector Height	7.35 mm
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PCB Thickness (Recommended)	1.5 mm [.059 in]
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Compatible Insulation Diameter Range	1.3 mm [.05 in]
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Wire Size	.22 – .35 mm ²
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Usage Conditions

Operating Temperature Range	-40 – 110 °C [-40 – 230 °F]
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Operation/Application

Circuit Application

Signal

Packaging Features

Packaging Quantity

280

Packaging Method

Tray

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU

Compliant

EU ELV Directive 2000/53/EC

Compliant

China RoHS 2 Directive MIIT Order No 32, 2016

No Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006

Current ECHA Candidate List: JUNE 2023 (235)
 Candidate List Declared Against: JUNE 2023 (235)
 Does not contain REACH SVHC

Halogen Content

Not Low Halogen - contains Br or Cl > 900 ppm.

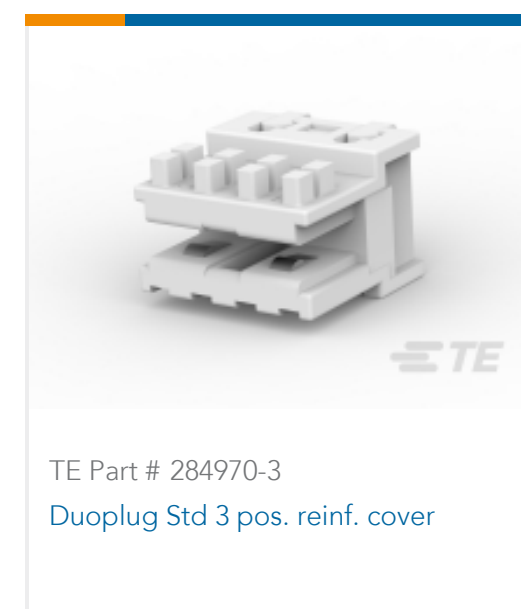
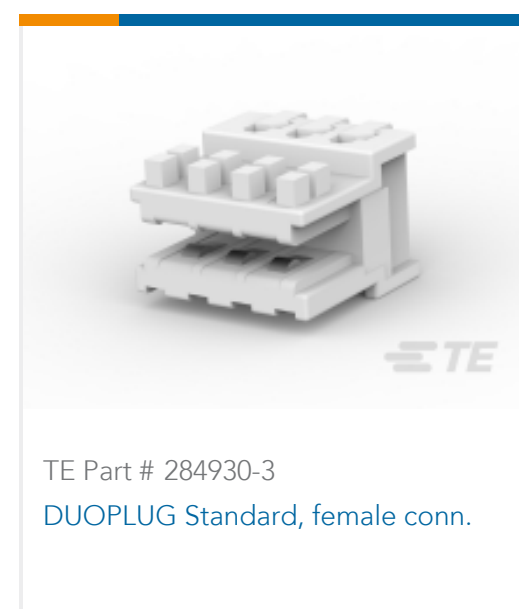
Solder Process Capability

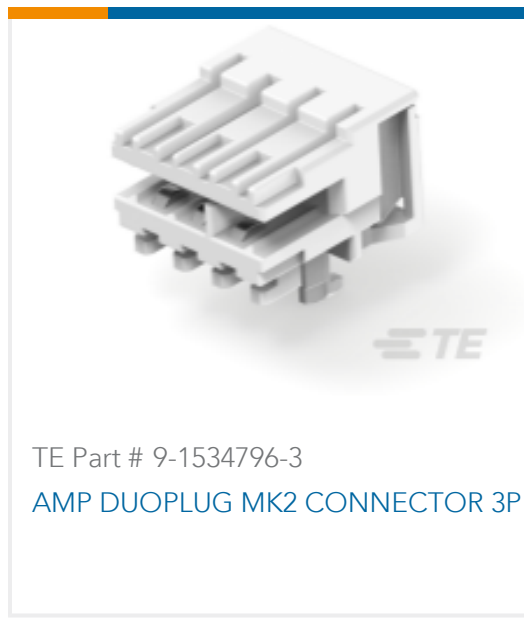
Not applicable for solder process capability

Product Compliance Disclaimer

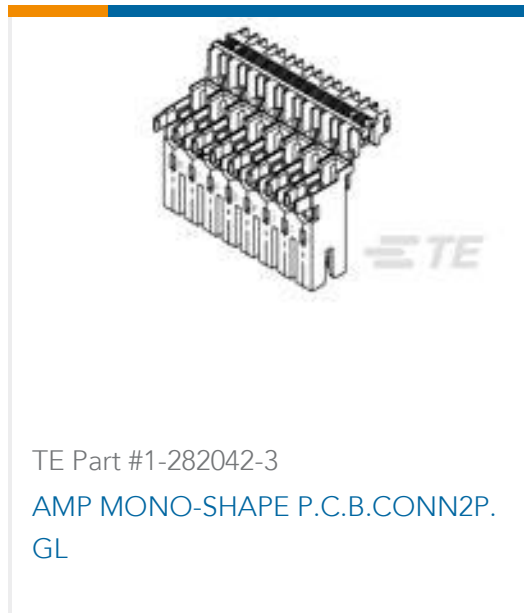
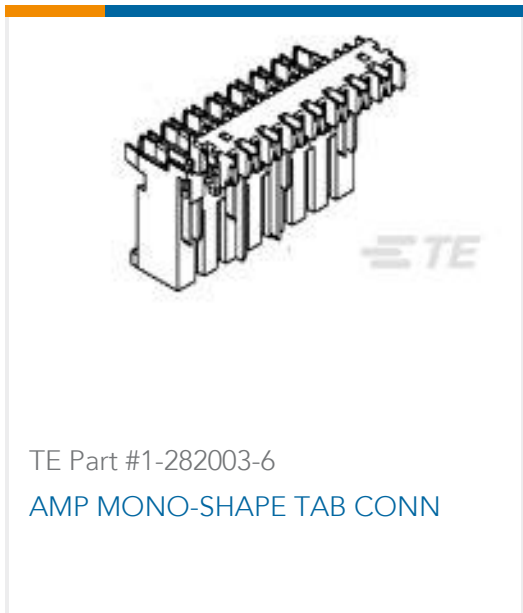
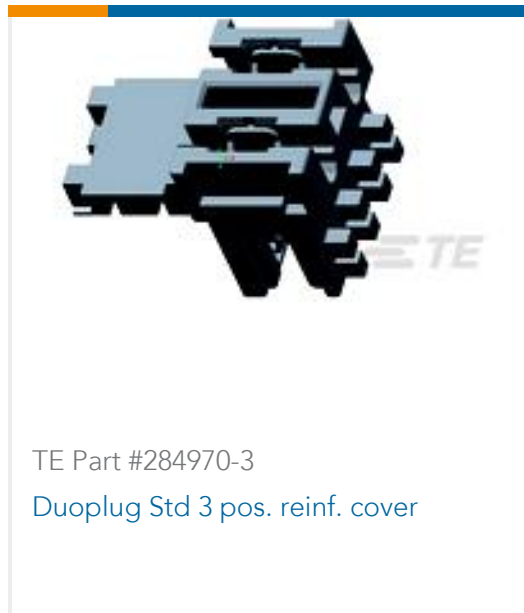
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts





Customers Also Bought



Documents

[CAD Files](#)

[3D PDF](#)

[3D](#)

[Customer View Model](#)

[ENG_CVM_CVM_3-284932-3_A_c-3-284932-3-a.2d_dxf.zip](#)

English

[Customer View Model](#)

[ENG_CVM_CVM_3-284932-3_A_c-3-284932-3-a.3d_igs.zip](#)

English



Customer View Model

[ENG_CVM_CVM_3-284932-3_A_c-3-284932-3-a.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Product Specifications

[Application Specification](#)

English

Product Environmental Compliance

[TE Material Declaration](#)

English

Agency Approvals

[Agency Approval Document](#)

English